SYSCO CORP Form FWP March 12, 2009

Filed Pursuant to Rule 433
Issuer Free Writing Prospectus dated
March 12, 2009 Relating to Preliminary Prospectus
Supplement dated March 12, 2009 to
Prospectus dated February 19, 2009
Registration No. 333-157413

FINAL PRICING TERMS

\$250,000,000 5.375% Senior Notes due 2019

Issuer: Sysco Corporation

Title of Security: 5.375% Senior Notes due 2019

Size: \$250,000,000

Maturity Date: March 17, 2019

Coupon: 5.375%

Interest Payment Dates: March 17 and September 17, commencing September 17, 2009

Price to Public: 99.321%

Benchmark Treasury: 2.75% due February 15, 2019

Benchmark Treasury Yield: 2.864%

Spread to Benchmark Treasury: T + 260 bps

Re-offer Yield: 5.464%

Make-Whole Call: T + 40 bps

Change of Control: Upon the occurrence of both (i) a change of control of Sysco Corporation and

(ii) a downgrade of the notes below an investment grade by two of the three rating agencies named below within a specified period, Sysco Corporation will be required to make an offer to purchase the notes at a price equal to 101% of

their principal amount, plus accrued and unpaid interest to the date of

repurchase.

Expected Settlement Date: T + 3; March 17, 2009

CUSIP Number: 871829 AM9

Anticipated Ratings: A1 by Moody s Investors Service, Inc.

A+ by Standard & Poor s Ratings Services

Joint Book-Running Managers: Goldman, Sachs & Co.

Banc of America Securities LLC

Co-Managers Barclays Capital

Mitsubishi UFJ Securities

TD Securities

Wachovia Securities BB&T Capital Markets BNY Capital Markets, Inc.

Comerica Securities

PNC Capital Markets LLC

The Williams Capital Group, L.P.

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\$250,000,000 6.625% Senior Notes due 2039

Issuer: Sysco Corporation

Title of Security: 6.625% Senior Notes due 2039

Size: \$250,000,000

Maturity Date: March 17, 2039

Coupon: 6.625%

Interest Payment Dates: March 17 and September 17, commencing September 17, 2009

Price to Public: 98.061%

Benchmark Treasury: 4.5% due May 15, 2038

Benchmark Treasury Yield: 3.627%

Spread to Benchmark Treasury: T + 315 bps

Re-offer Yield: 6.777%

Make-Whole Call: T + 50 bps

Change of Control: Upon the occurrence of both (i) a change of control of Sysco Corporation and

(ii) a downgrade of the notes below an investment grade by two of the three rating agencies named below within a specified period, Sysco Corporation will be required to make an offer to purchase the notes at a price equal to 101% of

their principal amount, plus accrued and unpaid interest to the date of

repurchase.

Expected Settlement Date: T + 3; March 17, 2009

CUSIP Number: 871829 AN7

Anticipated Ratings: Al by Moody s Investors Service, Inc.

A+ by Standard & Poor s Ratings Services

Joint Book-Running Managers: Goldman, Sachs & Co.

Banc of America Securities LLC

Co-Managers Barclays Capital

Mitsubishi UFJ Securities

TD Securities

Wachovia Securities BB&T Capital Markets BNY Capital Markets, Inc.

Comerica Securities PNC Capital Markets LLC The Williams Capital Group, L.P.

Note: A securities rating is not a recommendation to buy, sell or hold securities and may be subject to revision or withdrawal at any time.

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